(19) 世界知的所有権機關 国際事務局



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(43) 国際公開日 2001年5月31日(31.05.2001)

PCT

(10) 国際公開番号

(51) 国際特許分類7.

H05K 1/11 3/40 3/46

WO 01/39561 A1

(21) 国際出願番号:

PCT/JP00/08274

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(22) 国際出願日:

2000年11月24日(24.11.2000)

(25) 国際出願の言語:

日本語

(26) 国際公開の言語:

日本語

(30) 優先権データ: 特顯平11/335758

1999年11月26日(26.11.1999) JP

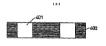
(72) 発明者: および

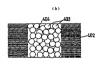
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(54) Title: WIRING BOARD AND PRODUCTION METHOD THEREOF

(54) 発明の名称: 配線基板およびその製造方法





(57) Abstract: A wiring board having a high reliability in the insulation and connection of wiring layers, and a production method thereof, the wiring board comprising wiring layers (407) consisting of at least two layers, insulation layers (402) interposed between wiring layers and containing organic resin, and vias (507) provided in insulation layers and extending up to the wiring layers, wherein vias contain functional matters (403) and clearances (404) with part of the clearances (first clearances) having organic resin seemed thereinto from insulation layers and the remaining clearances (second clearances) still filled with air, whereby the flowing of conductive paste into insulation layers, or so called paste bleeding, is eliminated. the second clearances in vias act to lower or soften the modulus of elasticity of the vias as a whole, and a stretching follow-up in response to a mechanical stress on the wiring board is improved to prevent the both wiring lavers from being wire-broken to thereby ensure high reliability in electrical and mechanical connections between the both wiring layers.

